5.6mm x 3.0mm SURFACE MOUNT LED

Part Number: KA-5630VB38Z4S

Blue



ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES

Features

- •Size (mm): 5.6 x 3.0 x 0.77
- •Suitable for all SMT assembly and solder process.
- Available on tape and reel.
- •White SMD package, silicone resin.
- •Moisture sensitivity level : level 2a.
- •RoHS compliant.

Description

The Blue source color devices are made with InGaN on Sapphire-substrate Light Emitting Diode.

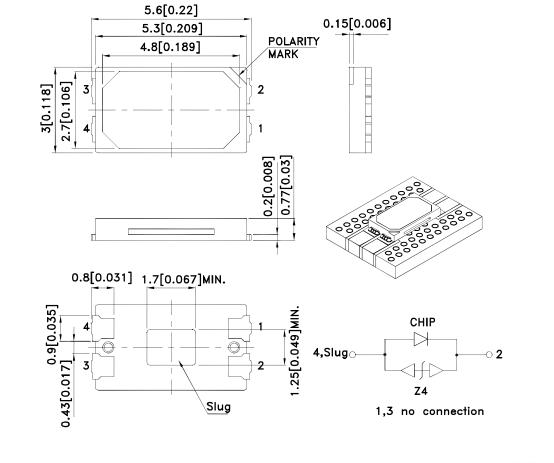
Static electricity and surge damage the LEDS.

It is recommended to use a wrist band or anti-electrostatic glove when handling the LEDs.

All devices, equipment and machinery must be electrically grounded.

Applications

- LCD TV / Monitor Backlight.
- Architectural lighting.
- Decorative lighting.



Notes: 1. All dimensions are in millimeters (inches).

2. Tolerance is ±0.25(0.01") unless otherwise noted.

The specifications, characteristics and technical data described in the datasheet are subject to change without notice.
The device has a single mounting surface. The device must be mounted according to the specifications.



SPEC NO: DSAM4933 APPROVED: WYNEC

REV NO: V.2B CHECKED: Allen Liu DATE: MAR/30/2013 DRAWN: F.Cui

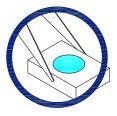
PAGE: 1 OF 8 ERP: 1201008321

Package Dimensions

Handling Precautions

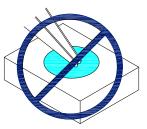
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surfaces by using forceps or appropriate tools.



2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.

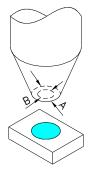




3. Do not stack together assembled PCBs containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry.



- 4.1. The inner diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks.
- 4.2. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup.
- 4.3. The dimensions of the component must be accurately programmed in the pick-and-place machine to insure precise pickup and avoid damage during production.



5. As silicone encapsulation is permeable to gases, some corrosive substances such as H_2S might corrode silver plating of leadframe. Special care should be taken if an LED with silicone encapsulation is to be used near such substances.

Detailed application notes are listed on our website. http://www.kingbright.com/application_notes

SPEC NO: DSAM4933 APPROVED: WYNEC REV NO: V.2B CHECKED: Allen Liu

DATE: MAR/30/2013 DRAWN: F.Cui PAGE: 2 OF 8 ERP: 1201008321

Part No.	Dice	Lens Type	lv (lm) [2] @ 120mA		Φv (lm) [2] @ 120mA			Viewing Angle [1]
			Min.	Тур.	Code.	Min.	Max.	201/2
KA-5630VB38Z4S	Blue (InGaN)	Water Clear	2.9	4	A11	2.9	3.5	120°
					A12	3.5	4.2	
					A13	4.2	5	
					A14	5	6	

Notes:

1. θ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

Luminous intensity/ luminous Flux: +/-15%.
LEDs are binned according to their luminous flux.
Luminous flux value is traceable to the CIE127-2007 compliant national standards.

Absolute Maximum Ratings at TA=25°C

Parameter	Symbol	Value	Unit	
Power Dissipation	PD	570	mW	
Junction Temperature [1]	TJ	110	°C	
Operating Temperature	Тор	-40 To +100	°C	
Storage Temperature	Tstg	-40 To +110	°C	
DC Forward Current [1]	lF	150	mA	
Reverse Voltage	VR	5	V	
Peak Forward Current [2]	Іғм	270	mA	
Thermal Resistance [1] (Junction/ambient)	Rth j-a	140	°C/W	
Thermal Resistance [1] (Junction/solder point)	Rth j-S	25	°C/W	
Electrostatic Discharge Threshold (HBM)		8000	V	

Notes:

1. Rth(j-a) Results from mounting on PC board FR4 (pad size≥16 mm² per pad),

2. 1/10 Duty Cycle, 0.1ms Pulse Width.

Electrical / Optical Characteristics at TA=25°C

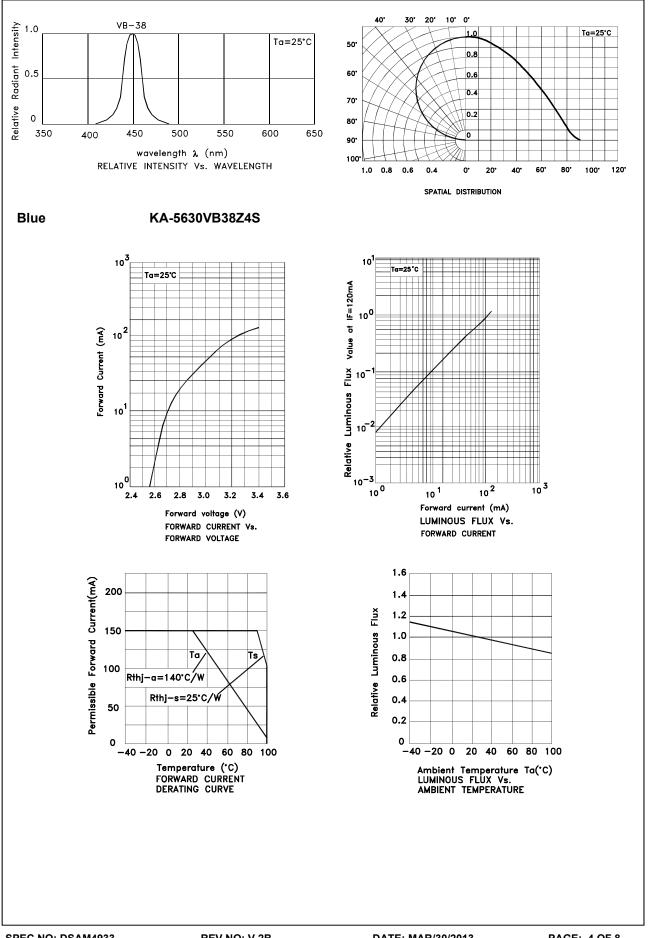
Devenuedar	Querra ha a l	Value		Unit
Parameter	Symbol	Тур.	Max.	Unit
Wavelength at peak emission IF=120mA	λpeak	445		nm
Dominant Wavelength IF=120mA	λ dom [1]	450		nm
Spectral bandwidth at 50% $\Phi_{\text{REL MAX}}$ IF=120mA	Δλ1/2	25		nm
Forward Voltage IF=120mA	VF [2]	3.3	3.8	V
Allowable Reverse Current	lR		85	mA
Temperature coefficient of λpeak I⊧=120mA, -10°C≤ T≤100°C	TCλpeak	0.12		nm/°C
Temperature coefficient of λdom I⊧=120mA, -10°C≤ T≤100°C	TCλdom	0.1		nm/°C
Temperature coefficient of V⊧ I⊧=120mA, -10°C≤ T≤100°C	TCv	-3.2		mV/°C

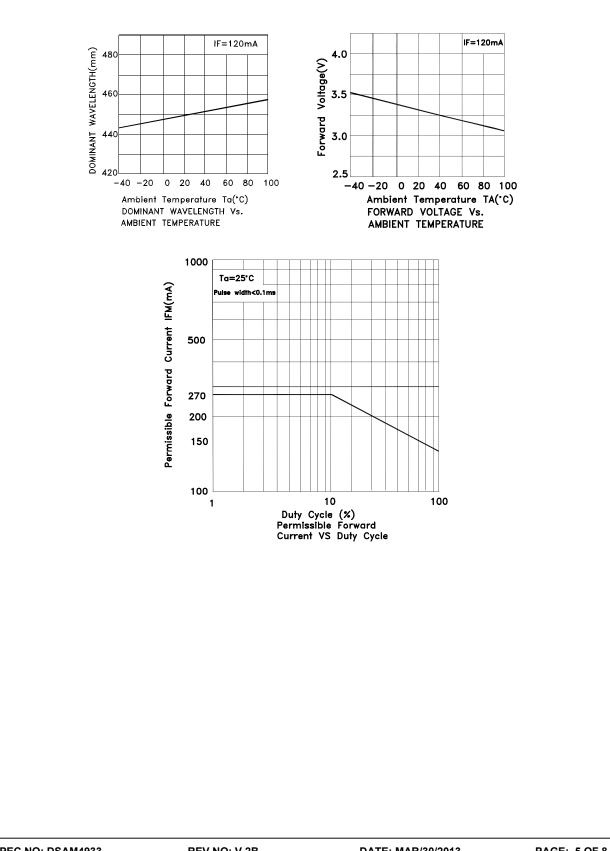
Notes:

1. The dominant Wavelength (λ d) above is the setup value of the sorting machine. (Tolerance λ d : ±1nm.)

2.Forward Voltage: +/-0.1V.

3.Wavelength value is traceable to the CIE127-2007 compliant national standards.





KA-5630VB38Z4S

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

